505506127 06/03/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT5552931

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PRADIP GIRDHAR CHAUDHARI	05/20/2019
CHE-HUI LEE	05/21/2019
WEN-CHENG YANG	05/21/2019

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16430179

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 949 387 2885
Email: inbox@wpatca.com

Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS

Address Line 1: 1100 QUAIL STREET, SUITE 202

Address Line 4: NEWPORT BEACH, CALIFORNIA 92660

ATTORNEY DOCKET NUMBER:	18506-1501	
NAME OF SUBMITTER:	ANTHONY KING	
SIGNATURE:	/Anthony King/	
DATE SIGNED:	06/03/2019	

Total Attachments: 2

source=P20183418US00-ASSG#page1.tif source=P20183418US00-ASSG#page2.tif

PATENT 505506127 REEL: 049353 FRAME: 0042

the United States and its territorial possessions;

ASSIGNMENT

WHEREAS, I(we), <u>CHAUDHARI, PRADIP GIRDHAR</u>, <u>LEE, CHE-HUI</u> and <u>YANG, WEN-CHENG</u> whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

ANALYZING METHOD (hereinafter referred to as the INVENTION) for which an application for United States Letters Parent /Uniting Parent

☐ United States Design☐ executed on:			
🗆 filed on:	Serial No.:		
	nternational Patent Application No.:	filed:	designating the
United States of America			
☐ issued on	as U.S. Patent No.:		
STREET DUTY OF THE LESS LAND TO STREET	AN ANALYSIN AN AN AND AN AN AN AN AND AND AND AND		
WHEREAS, IAIWAN SE	MICONDUCTOR MANUFACTUR	ING COMPAN	<u>Y LTD.</u> whose post office
address is NO.8, LI-HSI	N RD. 6, HSINCHU SCIENCE I	PARK, HSINC	HU, TAIWAN, R.O.C.
			iterest in and to the same in

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof, and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name CHAUDHARI, PRADIP GIRDHAR	Address 13F, NO.81, XINGUANG ROAD, HSINCHU CITY 30069, TAIWAN (R.O.C.)
Signature of Assignor Wasselver	Date of Signature 2019, May 20
Name of Witness (optional)	Name of Wilness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 049353 FRAME: 0043

eritar etilatur.	09/29/93/29	19 9 1700

Assignor Name LEE, CHE-HUI	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN, R.O.C.
Signature of Assignor (X) Leg	Date of Signature (X) Aboy > (> > 1)
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name YANG, WEN-CHENG	Address 2F., NO.20, ALY. 7, LN. 384, SEC. 1, ZHONGHUA RD., EAST DIST., HSINCHU CITY 300, TAIWAN (R.O.C.)
Signature of Assignor (X) (4)19-, WM-Cheng.	Date of Signature (X) > /9 , t >
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

-2-